

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
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SHIGETO HAYAFUJI	03/20/2014
TAKESHI KAMAYA	03/20/2014
HIROSHI HAYAKAWA	03/20/2014
YASUHIRO JINBO	03/20/2014
KANAME MOGAMI	03/20/2014
KENJI TAKESHITA	03/20/2014
MASANORI ARITOMI	03/20/2014
KUNIO YOSHIKAWA	03/20/2014
SABURO KIKUCHI	03/20/2014
AKIO ISHIDO	03/20/2014
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
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<b>NAME OF SUBMITTER:</b>	SEAN M. MCGINN, ESQ.
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<b>SIGNATURE:</b>	/Sean M. McGinn, Esq./
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<b>DATE SIGNED:</b>	03/27/2014
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**Total Attachments: 3**

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# ASSIGNMENT OF APPLICATION FOR PATENT

## WHEREAS

NAME AND ADDRESS  
OF ASSIGNOR

Shigeto HAYAFUJI of Tokyo, JAPAN;  
Takeshi KAMAYA of Yachiyo-shi, Chiba, JAPAN;  
Hiroshi HAYAKAWA of Chiba-shi, Chiba, Japan;  
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Masanori ARITOMI of Tokyo, JAPAN;  
Kunio YOSHIKAWA of Tokyo, JAPAN;  
Saburo KIKUCHI of Nagareyama-shi, Chiba, Japan; and  
Akio ISHIDO of Yokohama-shi, Kanagawa, Japan

(HEREINAFTER REFERRED TO AS ASSIGNOR) have invented  
and own a certain new and useful invention entitled:

TITLE OF INVENTION:

PROCESS AND DEVICE FOR REDUCING RADIOACTIVE  
MATERIAL OF OBJECT CONTAINING RADIOACTIVE  
MATERIAL TO SAFE LEVEL IN LIVING ENVIRONMENT  
(U.S. Patent Application No. 14/236,884)

## WHEREAS

FULL NAME AND ADDRESS  
OF ASSIGNEE

CDM CONSULTING CO., LTD.  
1-13-13, Tsukiji, Chuo-ku,  
Tokyo 1040045 Japan

RADWASTE AND DECOMMISSIONING CENTER  
Masumoto Bldg. 3F, 1-7-6, Toranomom, Minato-ku,  
Tokyo 1050001 Japan

(hereinafter referred to as ASSIGNEE), is desirous of  
acquiring the entire right, title, and interest in, to and under  
said invention and the United States Letters Patent to be  
obtained therefor:

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be

it known that in consideration of the payment of ASSIGNEE  
to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of  
which is hereby acknowledged, and for other good and  
valuable consideration, ASSIGNOR, by these presents, hereby  
sells, assigns and transfers to ASSIGNEE the entire and  
exclusive right, title and interest to said invention and all  
Letters Patent of the United States to be obtained therefor on  
said application or any continuation, division, renewal,  
substitute or reissue thereof for the full term or terms for  
which the same may be granted.

ASSIGNOR hereby authorizes and requests the Commissioner  
of Patents and Trademarks to issue said Letters Patent of the  
United States Patent obtained therefor on said application or any  
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continuation, division, renewal, substitute or reissue thereof for the full term or terms to said ASSIGNEE, of the entire right, title, and interest in and to the same, for his sole use and behoof, and for the use and behoof of his legal representatives, to the full end of the term or terms for which said Letters Patent obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for may be granted, as full and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

DATE OF SIGNING

IN WITNESS WHEREOF, I/We have hereunto set

hand and seal this 20 day of March, 2014.

SIGNATURE

By: 早名 天久  
Shigeto HAYAFUJI

SIGNATURE

By: 釜谷 武志  
Takeshi KAMAYA

SIGNATURE

By: 早川 宏  
Hiroshi HAYAKAWA

SIGNATURE

By: 神保 安弘  
Yasuhiro JINBO

SIGNATURE

By: 最上 要  
Kaname MOGAMI

SIGNATURE

By: 竹下 健二  
Kenji TAKESHITA

(Assignment of Application for Patent -- page 2 of 3)

SIGNATURE

By: 有田正憲  
Masanori ARITOMI

SIGNATURE

By: 吉川邦夫  
Kunio, YOSHIKAWA

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Saburo KIKUCHI

SIGNATURE

By: 石堂 昭夫  
Akio ISHIDO

WITNESSES

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(Assignment of Application for Patent -- page 3 of 3)